

SN754410 Quadruple Half-H Driver

1 Features

- 1-A Output-Current Capability Per Driver
- Applications Include Half-H and Full-H Solenoid Drivers and Motor Drivers
- Designed for Positive-Supply Applications
- Wide Supply-Voltage Range of 4.5 V to 36 V
- TTL- and CMOS-Compatible High-Impedance Diode-Clamped Inputs
- Separate Input-Logic Supply
- Thermal Shutdown
- Internal ESD Protection
- Input Hysteresis Improves Noise Immunity
- 3-State Outputs
- Minimized Power Dissipation
- Sink/Source Interlock Circuitry Prevents Simultaneous Conduction
- No Output Glitch During Power Up or Power Down
- Improved Functional Replacement for the SGS L293

2 Applications

- Stepper Motor Drivers
- DC Motor Drivers
- Latching Relay Drivers

3 Description

The SN754410 is a quadruple high-current half-H driver designed to provide bidirectional drive currents up to 1 A at voltages from 4.5 V to 36 V. The device is designed to drive inductive loads such as relays, solenoids, DC and bipolar stepping motors, as well as other high-current/high-voltage loads in positive-supply applications.

All inputs are compatible with TTL-and low-level CMOS logic. Each output (Y) is a complete totem-pole driver with a Darlington transistor sink and a pseudo-Darlington source. Drivers are enabled in pairs with drivers 1 and 2 enabled by 1,2EN and drivers 3 and 4 enabled by 3,4EN. When an enable input is high, the associated drivers are enabled and their outputs become active and in phase with their inputs. When the enable input is low, those drivers are disabled and their outputs are off and in a high-impedance state. With the proper data inputs, each pair of drivers form a full-H (or bridge) reversible drive suitable for solenoid or motor applications.

A separate supply voltage (V_{CC1}) is provided for the logic input circuits to minimize device power dissipation. Supply voltage V_{CC2} is used for the output circuits.

The SN754410 is designed for operation from -40°C to 85°C .

Device Information⁽¹⁾

PART NUMBER	PACKAGE (PIN)	BODY SIZE (NOM)
SN754410	PDIP (16)	19.80 mm × 6.35 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.

4 Simplified Schematic

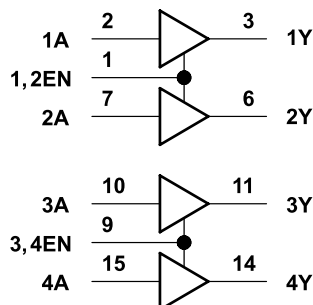


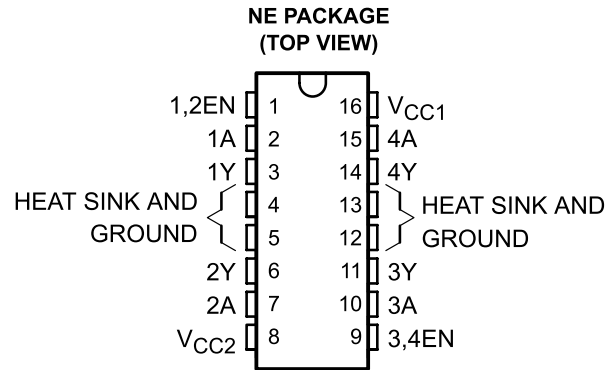
Table of Contents

1 Features	1	9.2 Functional Block Diagram	8
2 Applications	1	9.3 Feature Description	8
3 Description	1	9.4 Device Functional Modes	9
4 Simplified Schematic	1	10 Application and Implementation	10
5 Revision History	2	10.1 Application Information	10
6 Pin Configuration and Functions	3	10.2 Typical Application	10
7 Specifications	4	11 Power Supply Recommendations	11
7.1 Absolute Maximum Ratings	4	12 Layout	12
7.2 Recommended Operating Conditions	4	12.1 Layout Guidelines	12
7.3 Thermal Information	4	12.2 Layout Example	12
7.4 Electrical Characteristics	5	13 Device and Documentation Support	12
7.5 Switching Characteristics	5	13.1 Trademarks	12
7.6 Typical Characteristics	6	13.2 Electrostatic Discharge Caution	12
8 Parameter Measurement Information	7	13.3 Glossary	12
9 Detailed Description	8	14 Mechanical, Packaging, and Orderable Information	12
9.1 Overview	8		

5 Revision History

Changes from Revision B (November 1995) to Revision C	Page
Added <i>Applications</i>, <i>Device Information</i> table, <i>Pin Functions</i> table, <i>ESD Ratings</i> table, <i>Thermal Information</i> table, <i>Typical Characteristics</i>, <i>Feature Description</i> section, <i>Device Functional Modes</i>, <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section.	1
Deleted <i>Ordering Information</i> table.	1

6 Pin Configuration and Functions



Pin Functions

PIN		TYPE	DESCRIPTION
NAME	NO.		
1,2EN	1	I	Enable driver channels 1 and 2 (active high input)
<1:4>A	2, 7, 10, 15	I	Driver inputs, non-inverting
<1:4>Y	3, 6, 11, 14	O	Driver outputs
GROUND	4, 5, 12, 13	—	Device ground and heat sink pin. Connect to circuit board ground plane with multiple solid vias
V _{CC2}	8	—	Power VCC for drivers 4.5V to 36V
3,4EN	9	I	Enable driver channels 3 and 4 (active high input)
V _{CC1}	16	—	5V supply for internal logic translation

7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾⁽²⁾

		MIN	MAX	UNIT
V _{CC1}	Output supply voltage range	–0.5	36	V
V _{CC2}	Output supply voltage range	–0.5	36	V
V _I	Input voltage	–0.5	36	V
V _O	Output voltage range	–3	V _{CC2} + 3	V
I _P	Peak output current		±2	A
I _O	Continuous output current		±1	A
P _D	Continuous total power dissipation at (or below) 25°C free-air temperature ⁽³⁾		2075	mW
T _A	Operating free-air temperature range	–40	85	°C
T _J	Operating virtual junction temperature range	–40	150	°C
T _{stg}	Storage temperature range		260	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to network GND.
- (3) For operation above 25°C free-air temperature, derate linearly at the rate of 16.6 mW/°C. To avoid exceeding the design maximum virtual junction temperature, these ratings should not be exceeded. Due to variations in individual device electrical characteristics and thermal resistance, the built-in thermal overload protection can be activated at power levels slightly above or below the rated dissipation.

7.2 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V _{CC1}	Logic supply voltage	4.5	5.5	V
V _{CC2}	Output supply voltage	4.5	36	V
V _{IH}	High-level input voltage	2	5.5	V
V _{IL}	Low-level input voltage	–0.3 ⁽¹⁾	0.8	V
T _J	Operating virtual junction temperature	–40	125	°C
T _A	Operating free-air temperature	–40	85	°C

- (1) The algebraic convention, in which the least positive (most negative) limit is designated as minimum, is used in this data sheet for logic voltage levels.

7.3 Thermal Information

THERMAL METRIC ⁽¹⁾		SN754410	UNIT
		NE	
		16 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	60	°C/W

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

7.4 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{IK} Input clamp voltage	$I_I = -12 \text{ mA}$		-0.9	-1.5	V
V_{OH} High-level output voltage	$I_{OH} = -0.5 \text{ A}$	$V_{CC2} - 1.5$	$V_{CC2} - 1.1$		V
	$I_{OH} = -1 \text{ A}$	$V_{CC2} - 2$			
	$I_{OH} = -1 \text{ A}, T_J = 25^\circ\text{C}$	$V_{CC2} - 1.8$	$V_{CC2} - 1.4$		
V_{OL} Low-level output voltage	$I_{OL} = 0.5 \text{ A}$		1	1.4	V
	$I_{OL} = 1 \text{ A}$			2	
	$I_{OL} = 1 \text{ A}, T_J = 25^\circ\text{C}$		1.2	1.8	
V_{OKH} High-level output clamp voltage	$I_{OK} = -0.5 \text{ A}$	$V_{CC2} + 1.4$	$V_{CC2} + 2$		V
	$I_{OK} = 1 \text{ A}$	$V_{CC2} + 1.9$	$V_{CC2} + 2.5$		
V_{OKL} Low-level output clamp voltage	$I_{OK} = 0.5 \text{ A}$		-1.1	-2	V
	$I_{OK} = -1 \text{ A}$		-1.3	-2.5	
$I_{OZ(off)}$ Off-state high-impedance-state output current	$V_O = V_{CC2}$			500	μA
	$V_O = 0$			-500	
I_{IH} High-level input current	$V_I = 5.5 \text{ V}$			10	μA
I_{IL} Low-level input current	$V_I = 0$			-10	μA
I_{CC1} Output supply current	$I_O = 0$	All outputs at high level		38	mA
		All outputs at low level		70	
		all outputs at high impedance		25	
I_{CC2} Output supply current	$I_O = 0$	All outputs at high level		33	nA
		All outputs at low level		20	
		All outputs at high impedance		5	

7.5 Switching Characteristics

over operating free-air temperature range (unless otherwise noted), $V_{CC1} = 5 \text{ V}$, $V_{CC2} = 24 \text{ V}$, $C_L = 30 \text{ pF}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{d1} Delay time, high-to-low-level output from A input	See Figure 3		400		ns
t_{d2} Delay time, low-to-high-level output from A input			800		ns
t_{TLH} Transition time, low-to-high-level output			300		ns
t_{THL} Transition time, high-to-low-level output			300		ns
t_{en1} Enable time to the high level	See Figure 4		700		ns
t_{en2} Enable time to the low level			400		ns
t_{dis1} Disable time from the high level			900		ns
t_{dis2} Disable time from the low level			600		ns

7.6 Typical Characteristics

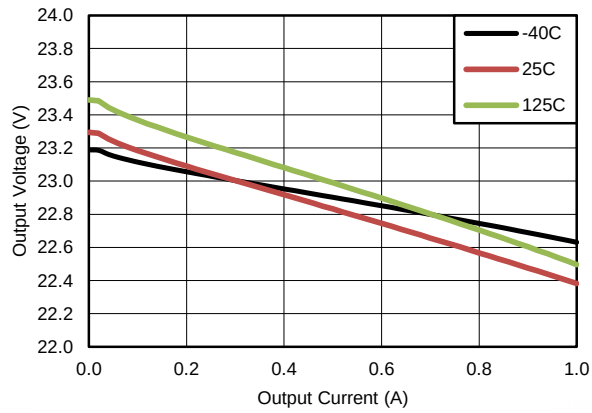
 $V_{CC1} = 5\text{ V}$, $V_{CC2} = 24\text{ V}$


Figure 1. V_{OH} vs I_{OH}

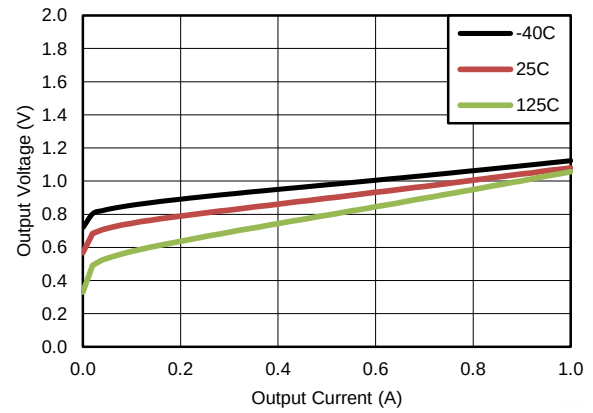
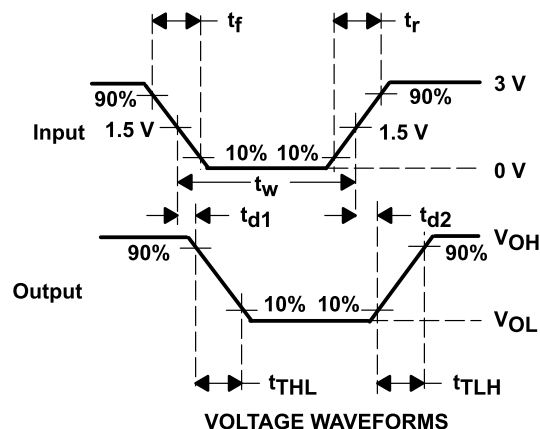
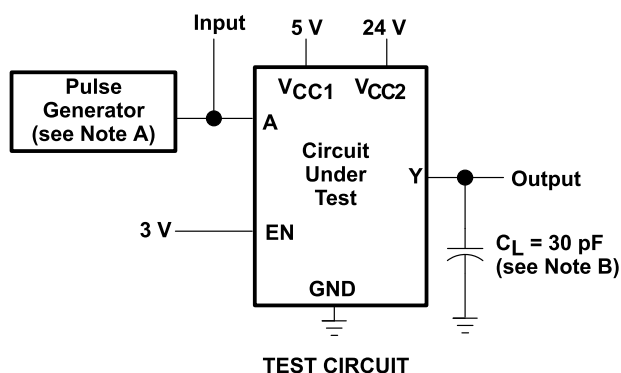


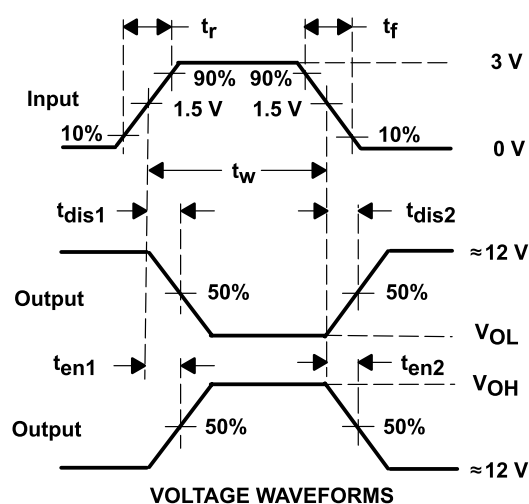
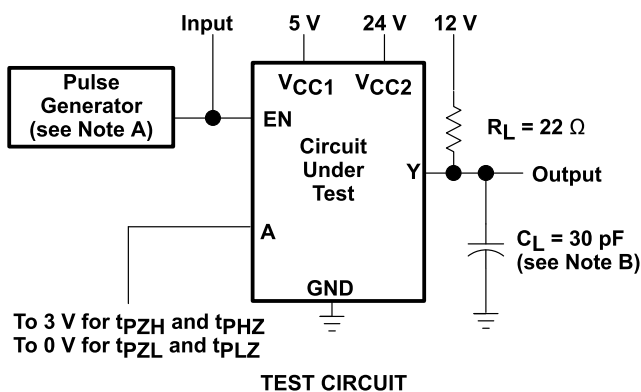
Figure 2. V_{OL} vs I_{OL}

8 Parameter Measurement Information



- A. The pulse generator has the following characteristics: $t_r \leq 10$ ns, $t_f \leq 10$ ns, $t_w = 10$ μ s, $P_{RR} = 5$ kHz, $Z_O = 50$ Ω
 B. C_L includes probe and jig capacitance.

Figure 3. Test Circuit and Switching Times from Data Inputs



- A. The pulse generator has the following characteristics: $t_r \leq 10$ ns, $t_f \leq 10$ ns, $t_w = 10$ μ s, $P_{RR} = 5$ kHz, $Z_O = 50$ Ω
 B. C_L includes probe and jig capacitance.

Figure 4. Test Circuit and Switching Times from Enable Inputs

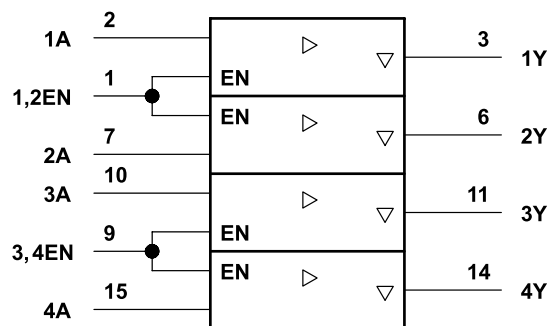
9 Detailed Description

9.1 Overview

The SN754410 is a quadruple high-current half-H driver designed to provide bidirectional drive currents up to 1 A at voltages from 4.5 V to 36 V. The device is designed to drive inductive loads such as relays, solenoids, DC and bipolar stepping motors, as well as other high-current/high-voltage loads in positive-supply applications. All inputs are compatible with TTL and low-level CMOS logic. Each output (Y) is a complete totem-pole driver with a Darlington transistor sink and a pseudo-Darlington source. Drivers are enabled in pairs with drivers 1 and 2 enabled by 1,2EN and drivers 3 and 4 enabled by 3,4EN. When an enable input is high, the associated drivers are enabled and their outputs become active and in phase with their inputs. When the enable input is low, those drivers are disabled and their outputs are off and in a high-impedance state. With the proper data inputs, each pair of drivers form a full-H (or bridge) reversible drive suitable for solenoid or motor applications.

A separate supply voltage (V_{CC1}) is provided for the logic input circuits to minimize device power dissipation. Supply voltage V_{CC2} is used for the output circuits. The SN754410 is designed for operation from -40°C to 85°C .

9.2 Functional Block Diagram



This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

9.3 Feature Description

9.3.1 High Current, High Voltage Outputs

Four high current and high voltage outputs feature clamp diodes for inductive load driving.

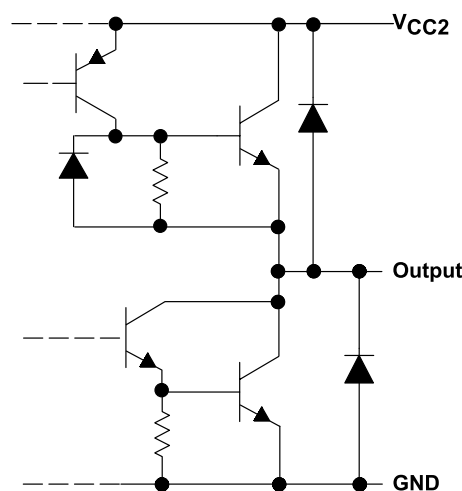


Figure 5. Typical of All Outputs

Feature Description (continued)

9.3.2 TTL Compatible Inputs

Data inputs and enable inputs are compatible with TTL. 3.3-V CMOS logic is also acceptable, however open or high impedance input voltage can approach V_{CC1} voltage.

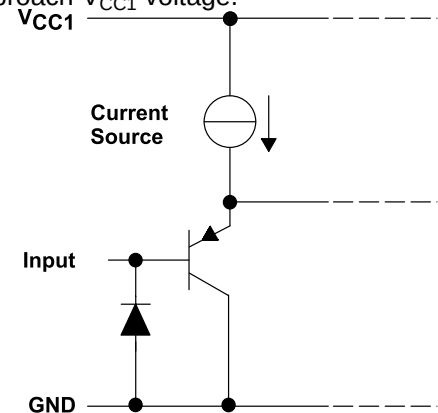


Figure 6. Equivalent of Each Input

9.4 Device Functional Modes

Table 1. Function Table⁽¹⁾

INPUTS ⁽²⁾		OUTPUTS Y
A	EN	
H	H	H
L	H	L
X	L	Z

- (1) H = high-level
L = low-level
X = irrelevant
Z = high-impedance (off)
- (2) In the thermal shutdown mode, the output is in a high-impedance state regardless of the input levels.

10 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

10.1 Application Information

Provide a 5-V supply to V_{CC1} and valid logic input levels to data and enable inputs. V_{CC2} must be connected to a power supply capable of supplying the needed current and voltage demand for the loads connected to the outputs.

10.2 Typical Application

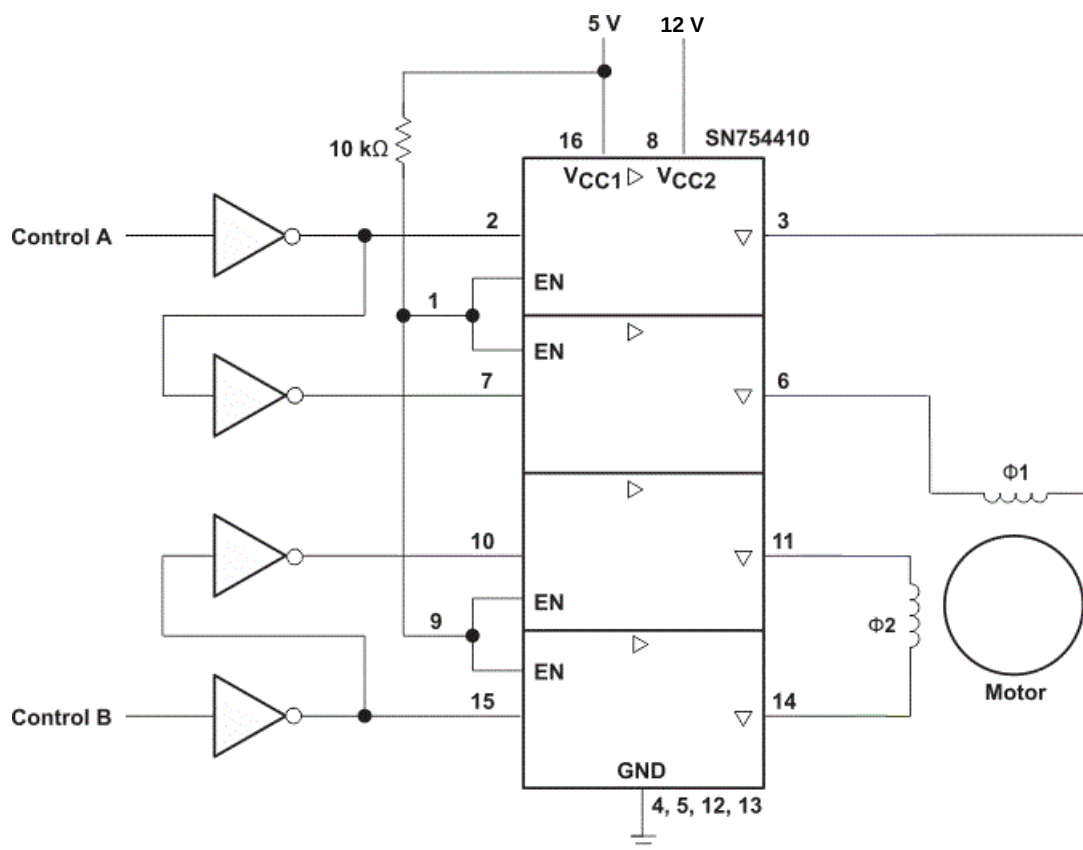


Figure 7. Typical Application Schematic

10.2.1 Design Requirements

The design techniques in the following sections may be used for applications which fall within the following requirements.

- 4.5-V minimum and 36-V maximum V_{CC2} voltage
- 1000-mA or less output current per channel
- 5-V supply with 10% tolerance or less
- TTL compatible logic inputs

Typical Application (continued)

10.2.2 Application Curves

Driver output voltage waveform with a two phase stepper motor; 12-V 20-Ω coils.

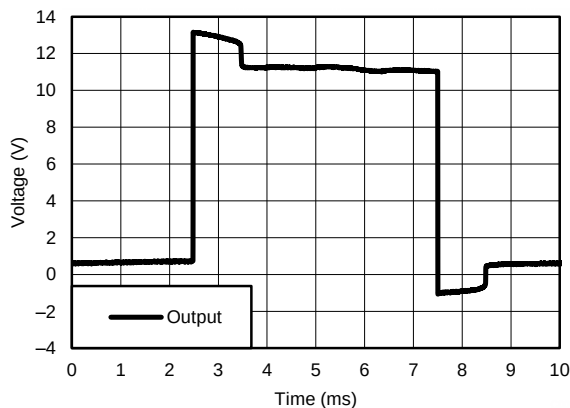


Figure 8. 100 Hz Driver Output Waveform

11 Power Supply Recommendations

V_{CC1} is 5 V $\pm$ 0.5 V and V_{CC2} can be same supply as V_{CC1} or a higher voltage supply with peak voltage up to 36 V. Bypass capacitors of 0.1 μ F or greater should be used at V_{CC1} and V_{CC2} pins. There are no power up or power down supply sequence order requirements.

12 Layout

12.1 Layout Guidelines

Place device near the load to keep output traces short to reduce EMI. Use solid vias to transfer heat from ground pins to circuit board's ground plane.

12.2 Layout Example

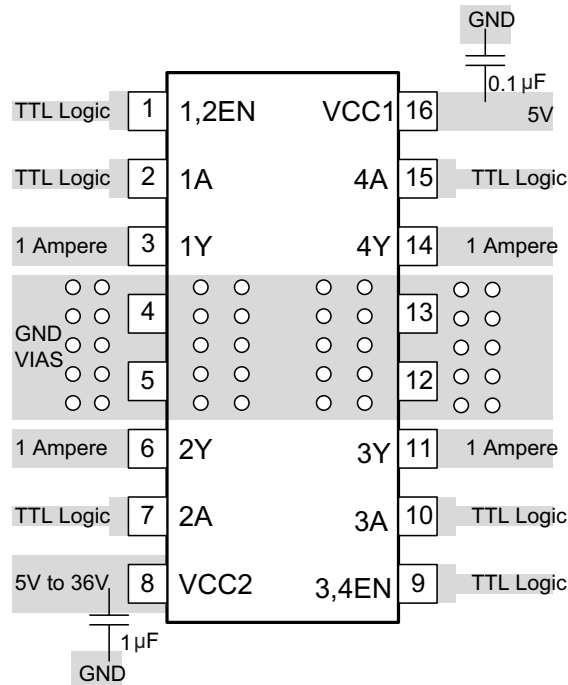


Figure 9. Layout Diagram

13 Device and Documentation Support

13.1 Trademarks

All trademarks are the property of their respective owners.

13.2 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

13.3 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN754410NE	Active	Production	PDIP (NE) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	SN754410NE
SN754410NE.A	Active	Production	PDIP (NE) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	SN754410NE
SN754410NEE4	Active	Production	PDIP (NE) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	SN754410NE

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

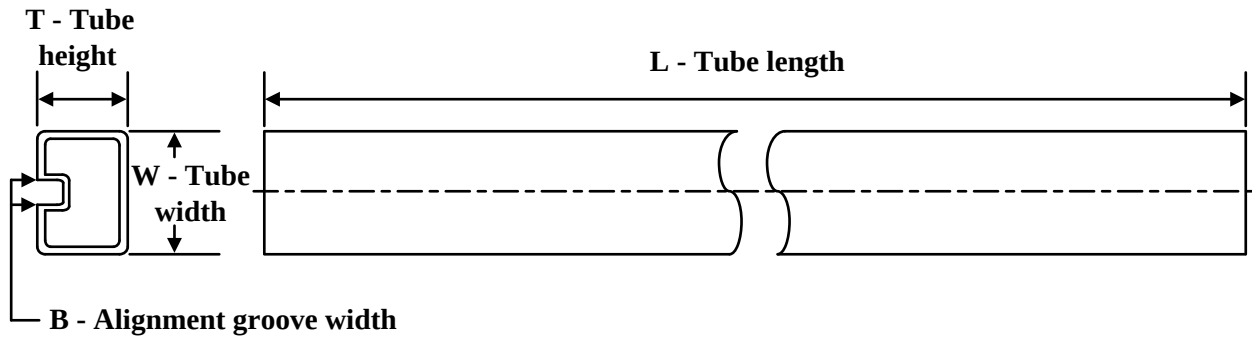
⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TUBE



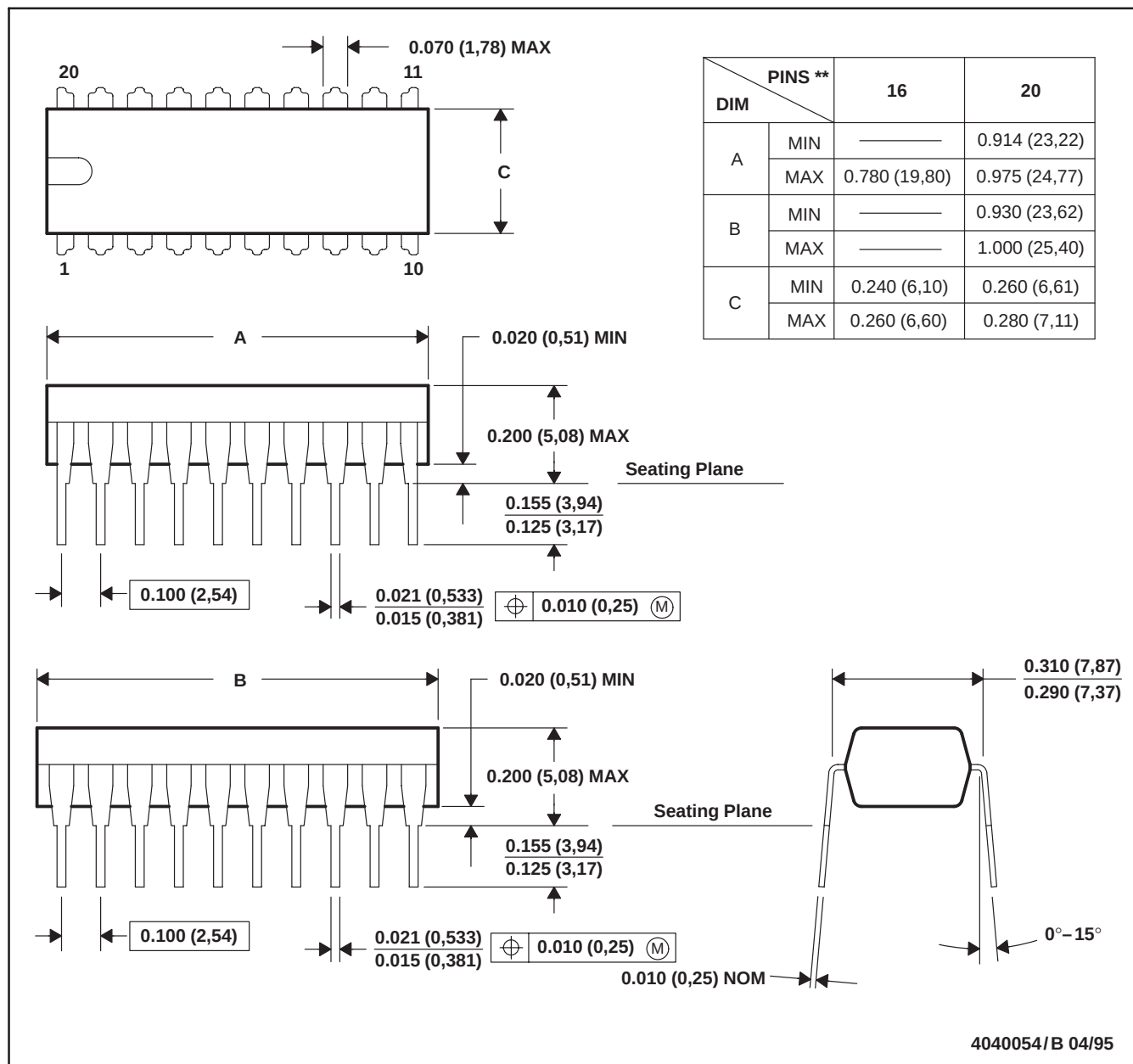
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN754410NE	NE	PDIP	16	25	506	13.97	11230	4.32
SN754410NE.A	NE	PDIP	16	25	506	13.97	11230	4.32
SN754410NEE4	NE	PDIP	16	25	506	13.97	11230	4.32

NE (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

20 PIN SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Falls within JEDEC MS-001 (16 pin only)

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#), [TI's General Quality Guidelines](#), or other applicable terms available either on [ti.com](#) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2026, Texas Instruments Incorporated

Last updated 10/2025